

<b>ENGINEERING</b>  <b>DEPT.</b>	<b>PRODUCT SPECIFICATION</b>  <b>For CI88 Series Connector System</b>	<b>SPEC.NO.: SPCI134A</b>  <b>PAGE: 1/3</b>
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1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and procedure with terminals crimped on the specified maximum size wire

2. APPLICABLE STANDARDS:

MIL - STD - 202	Methods for test of connectors for electronic equipment
MIL - STD - 1344	Test methods for electrical connectors
SS-00254	Test methods for electronic components ,LEAD-FREE soldering Part design standards

3. APPLICABLE SERIES NO.: CI88 Series

4. SHAPE, CONSTRUCTION AND DIMENSIONS

See attached drawings

5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

6.1 Thickness: 1.6 mm (.063")

6.2 P.C. Board Layout: See attached drawings



REVIEWED : David APPROVED : Eisley VERIFIED : Hank .

<b>ENGINEERING DEPT.</b>	<b>PRODUCT SPECIFICATION For CI88 Series Connector System</b>	<b>SPEC.NO.: SPCI134A</b>
		<b>PAGE: 2/3</b>

**7. ELECTRICAL PERFORMANCE:**

	ITEM	TEST CONDITION	REQUIREMENT
7.1	Rated current and voltage		4A 250V AC (r.m.s.)
7.2	Contact resistance	Dry circuit of DC 20 mV max. , 100 mA max.	Less than 10 mΩ
7.3	Dielectric strength	When applied AC 750 V 1 minute between adjacent terminal	No change
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than 5000 MΩ

**8. MECHANICAL PERFORMANCE:**

	ITEM	TEST CONDITION	REQUIREMENT
8.1	Pin retention force	Push pin from insulator base at speed 25± 3 mm per minute	More than 1.36 Kgf

**9. ENVIRONMENTAL PERFORMANCE:**

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Temperature rise	Then carried the rated current	30°C max.
9.2	Vibration	1.5 mm 10-55-10 HZ / minute each 2 hours for X , Y and Z directions	Appearance: No damage Discontinuity: 1 micro second max.
9.3	Solder ability	<b>Lead-Free Process:</b> Soldering time: 3 ± 0.5 second Soldering pot: 245 ± 5°C	Minimum: 90% of immersed area
9.4	Resistance to soldering heat	<b>Lead-Free Process</b> Soldering time: 5 ± 0.5 second Soldering pot: 260 ± 5°C	No damage

<b>ENGINEERING DEPT.</b>	<b>PRODUCT SPECIFICATION For CI88 Series Connector System</b>	<b>SPEC.NO.: SPCI134A</b>
		<b>PAGE: 3/3</b>

	ITEM	TEST CONDITION	REQUIREMENT
9.5	Heat aging	85 ± 2°C , 96 hours	No damage
9.6	Humidity	40 ± 2°C , 90-95% RH , 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 7-3
9.7	Temperature cycling	One cycle consists of : (1)-55 <sup>+0</sup> / <sub>-3</sub> °C , 30 min. (2)Room temp. 10-15 min. (3) 105 <sup>+3</sup> / <sub>-0</sub> °C , 30 min. (4)Room temp. 10-15 min. Total cycles: 5 cycles	Appearance: No damage Contact resistance: Less than twice of initial
9.8	Salt spray	Temperature: 35 ± 3°C Solution: 5 ± 1% Spray time: 48 ± 4 hours Measurement must be taken after water rinse	Appearance: No damage Contact resistance: Less than twice of initial

10. AMBIENT TEMPERATURE RANGE: -55 to + 105°C(Including terminal temperature rise)